

Ultra-Low VF Schottky Rectifier

20 A, 100 V

FSV20100V

Features

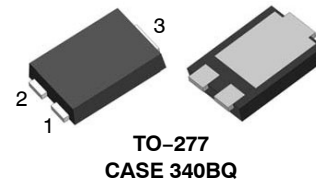
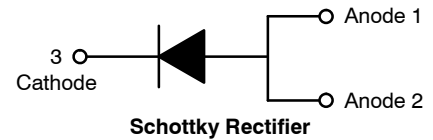
- Ultra-Low Forward Voltage Drop
- Low Thermal Resistance
- Very Low Profile: Typical Height of 1.1 mm
- Trench Schottky Technology
- Green Molding Compound as per IEC61249 Standard
- Non-DAP Option Only
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

Specifications

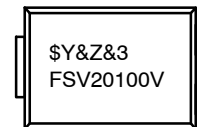
ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Rating	Value	Unit
V_{RRM}	Peak Repetitive Reverse Voltage	100	V
V_{RWM}	Working Peak Reverse Voltage	100	V
V_{RMS}	RMS Reverse Voltage	70	V
V_R	DC Blocking Voltage	100	V
$I_{F(AV)}$	Average Rectified Peak Forward Surge Current	20	A
I_{FSM}	Non-Repetitive Peak Forward Surge Current	270	A
T_J	Operating Junction Temperature Range	-55 to +150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to +150	$^\circ\text{C}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



MARKING DIAGRAM



\$Y = onsemi Logo
 &Z = Assembly Plant Code
 &3 = Date Code (Year & Week)
 FSV20100V = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

FSV20100V

THERMAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted) (Note 1)

Symbol	Characteristic	Minimum Land Pattern	Maximum Land Pattern	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance	100	40	$^\circ\text{C/W}$
Ψ_{JL}	Junction-to-Lead Thermal Characteristics, Thermocouple Soldered to Anode	15	12	$^\circ\text{C/W}$
	Junction-to-Lead Thermal Characteristics, Thermocouple Soldered to Cathode	6	5	

1. The thermal resistances ($R_{\theta JA}$ & Ψ_{JL}) are characterized with device mounted on the following FR4 printed circuit boards, as shown in Figure 1 and Figure 2. PCB size: 76.2 x 114.3 mm. Minimum land pattern size: 4.9 x 4.8 mm (big pattern, x1), 1.4 x 1.52 mm (small pattern, x2). Maximum land pattern size: 30 x 30 mm (pattern, x2). Force line trace size = 55 mils, sense line trace size = 4 mils.



Figure 1. Minimum Land Pattern of 2 oz Copper

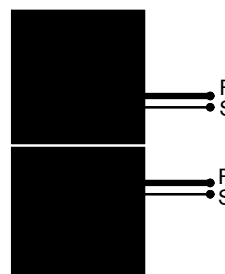


Figure 2. Maximum Land Pattern of 2 oz Copper

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
BV_R	Breakdown Voltage	$I_R = 0.5 \text{ mA}$	100	–	–	V
V_F	Forward Voltage Drop	$I_F = 20 \text{ A}$	–	–	0.66	V
I_R	Reverse Current	$V_R = 100 \text{ V}$	–	–	80	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping [†]
FSV20100V	FSV20100V	TO-277 3L (Pb-Free/Halogen Free)	5000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

TYPICAL PERFORMANCE CHARACTERISTICS

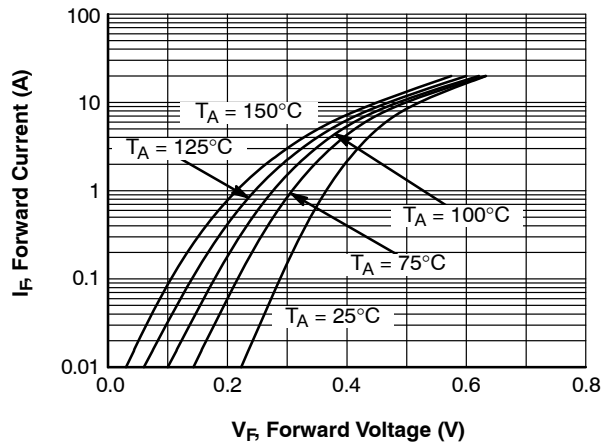


Figure 3. Typical Forward Characteristics

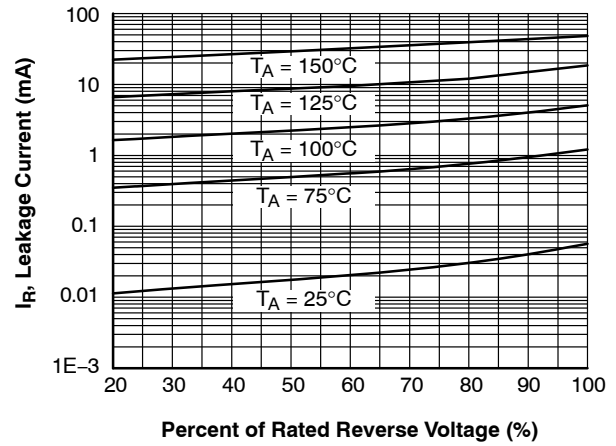


Figure 4. Typical Reverse Characteristics

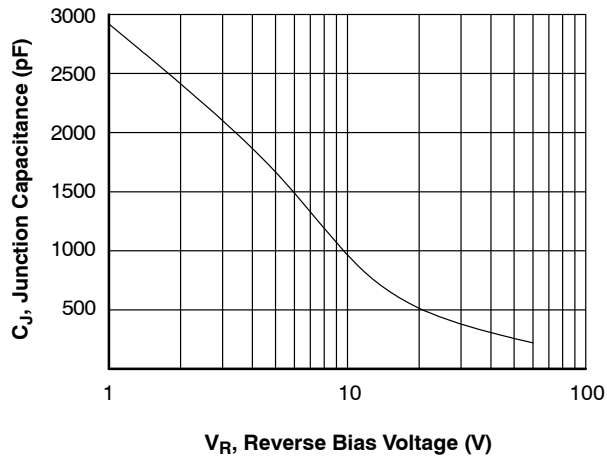


Figure 5. Typical Junction Capacitance

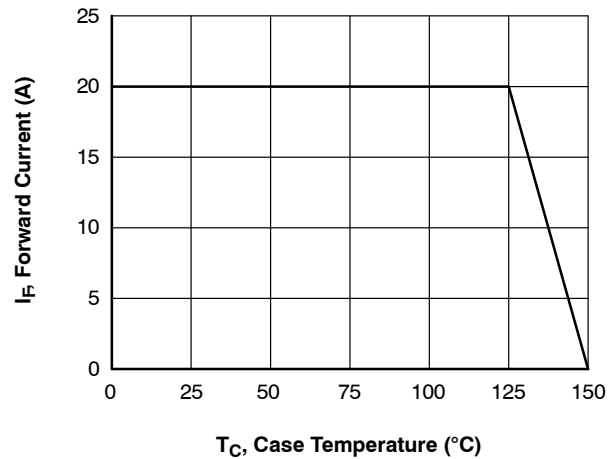
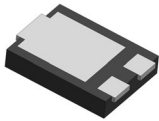


Figure 6. Forward Current Derating Curve

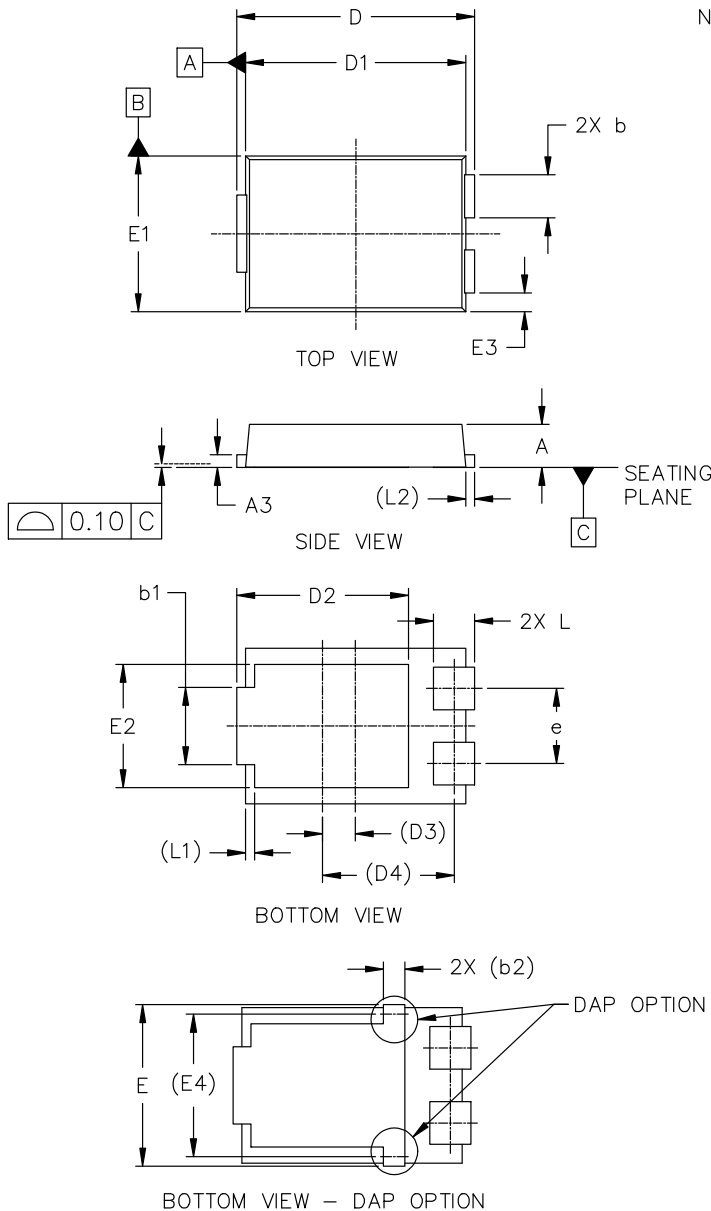


TO-277-3 5.91x4.44x1.10, 2.10P
CASE 340BQ
ISSUE A

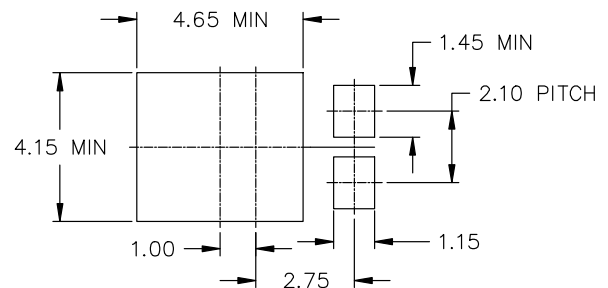
DATE 16 APR 2026

NOTES:

1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M, 2018.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD FLASH, MOLD FLASH SHALL NOT EXCEED 0.13 mm PER SIDE.



MILLIMETERS			
DIM	MIN	NOM	MAX
A	1.00	1.10	1.20
A3	0.23	0.32	0.40
b	1.10	1.25	1.40
b1	1.95	2.10	2.25
b2	0.60 REF		
D	6.35	6.50	6.65
D1	5.67	5.91	6.15
D2	4.23	4.57	4.90
D3	0.913 REF		
D4	3.680 REF		
E	---	---	4.75
E1	4.25	4.44	4.63
E2	3.25	3.48	3.70
E3	0.43	0.53	0.63
E4	3.680 REF		
e	2.00	2.10	2.20
L	0.90	1.08	1.25
L1	0.25 REF		
L2	0.35 REF		



RECOMMENDED MOUNTING FOOTPRINT

*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	TO-277-3 5.91x4.44x1.10, 2.10P	PAGE 1 OF 1

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